Renesas Electronics America Inc - R5F5631MCDFM#V0 Datasheet

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, I²C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	42
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 12x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631mcdfm-v0

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and table 1.2 gives a comparison of the functions of products in different packages.
Table 1.1 is for products with the greatest number of functions, so numbers of peripheral modules and channels will differ in accord with the package. For details, see Table 1.2, Comparison of Functions for Different Packages in the RX63N/RX631 Group.

Table 1.1 Outline of Specifications (1/6)

Classification	Module/Function	Description
CPU	CPU	• Maximum operating frequency: 100 MHz • 32-bit RX CPU • Minimum instruction execution time: One instruction per state (cycle of the system clock) • Address space: 4-Gbyte linear • Register set of the CPU General purpose: Sixteen 32-bit registers Control: Nine 32-bit registers Accumulator: One 64-bit register • Basic instructions: 73 • Floating-point instructions: 8 • DSP instructions: 9 • Addressing modes: 10 • Data arrangement Instructions: Little endian Data: Selectable as little endian or big endian • On-chip 32-bit multiplier: 32 x 32 → 64 bits • On-chip divider: 32 / 32 → 32 bits • Barrel shifter: 32 bits • Memory protection unit (MPU)
	FPU	• Single precision (32-bit) floating point • Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	• Capacity: ROMless, 256 Kbytes, 384 Kbytes, 512 Kbytes, 768 Kbytes, 1 Mbyte, 1.5 Mbytes, 2 Mbytes • 100 MHz, no-wait access • On-board programming: Four types • Off-board programming (parallel programmer mode) (for products with 100 pins or more)
	RAM	• Capacity: 64 Kbytes, 128 Kbytes, 192 Kbytes, 256 Kbytes • 100 MHz, no-wait access
	E2 data flash	Capacity: 32 Kbytes Programming/erasing: 100,000 times
MCU operating modes		Single-chip mode, on-chip ROM enabled expansion mode, and on-chip ROM disabled expansion mode (software switching)
Clock	Clock generation circuit	• Main clock oscillator, subclock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator • Main-clock oscillation stoppage detection • Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clock (PCLK), FlashIF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 100 MHz Peripheral modules run in synchronization with the peripheral module clock (PCLK): Up to 50 MHz Flash IF run in synchronization with the flashIF clock (FCLK): Up to 50 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 50 MHz
Reset		RES# pin reset, power-on reset, voltage-monitoring reset, independent watchdog timer reset, watchdog timer reset, deep software standby reset, and software reset
Voltage detection circuit		When the voltage on VCC passes the voltage detection level (Vdet), an internal reset or internal interrupt is generated.

Table 1.4 Pin Functions (2/6)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode.
	WR0# to WR3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0# to BC3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode.
	ALE	Output	Address latch signal when address/data multiplexed bus is selected.
	CKE	Output	Output pin for SDRAM clock enable signals.
	SDCS#	Output	Output pin for SDRAM chip select signals.
	RAS#	Output	Output pin for SDRAM row address strobe signals.
	CAS#	Output	Output pin for SDRAM column address strobe signals.
	WE#	Output	Output pin for SDRAM write enable signals.
	DQM0 to DQM3	Output	Output pins for SDRAM I/O data mask enable signals.
	CS0# to CS7#	Output	Select signals for CS area.
	WAIT#	Input	Input pins for wait request signals in access to the external space.
EXDMA controller	EDREQ0, EDREQ1		Input pins for external DMA transfer requests.
	EDACK0, EDACK1		Output pins for single address transfer acknowledge signals.
Interrupt	NMI	Input	Non-maskable interrupt request signal.
	IRQ0 to IRQ15	Input	Maskable interrupt request signals.
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/dead time compensation input pins.
	MTCLKA, MTCLKB MTCLKC, MTCLKD	Input	Input pins for external clock signals.
Port output enable 2	POE0# to POE3# POE8#	Input	Input pins for request signals to place the MTU large-current pins in the high impedance state.

Table 1.6 List of Pin and Pin Functions (176-Pin LQFP) (4/5)

Pin Number 176-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIc, SCId, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
100		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	ET_ERXD0/RMII_RXD0/ TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/SSDA6	IRQ4-DS	
101		P72	CS2#		ET_MDC		
102		P71	CS1#		ET_MDIO		
103	VCC						
104		PB0	A8	MTIC5W/TIOCA3/PO24	ET_ERXD1/RMII_RXD1/ RXD4/RXD6/SMISO4/ SMISO6/SSCL4/SSCL6/ RSPCKA	IRQ12	
105	VSS						
106		PA7	A7	TIOCB2/PO23	ET_WOL/MISOA		
107		PA6	A6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	ET_EXOUT/CTS5#/ RTS5#/SS5#/MOSIA		
108		PA5	A5	TIOCB1/PO21	ET_LINKSTA/RSPCKA		
109		PA4	A4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	ET_MDC/TXD5/SMOSI5/ SSDA5/SSLA0	IRQ5-DS	
110		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	ET_MDIO/RXD5/SMISO5/ SSCL5	IRQ6-DS	
111	TRDATA3	PG7	D31				
112		PA2	A2	PO18	RXD5/SMISO5/SSCL5/ SSLA3		
113	TRDATA2	PG6	D30				
114		PA1	A1/DQM3	MTIOC0B/MTCLKC/ TIOCB0/PO17	ET_WOL/SCK5/SSLA2	IRQ11	
115	VCC						
116	TRCLK	PG5	D29				
117	VSS						
118		PA0	A0/BC0#/DQM2	MTIOC4A/TIOCA0/PO16	ET_TX_EN/ RMII_TXD_EN/SSLA1		
119	TRSYNC	PG4	D28				
120		P67	CS7#/DQM1		CRX2*2	IRQ15	
121	TRDATA1	PG3	D27				
122		P66	CS6#/DQM0		CTX2*2		
123	TRDATA0	PG2	D26				
124		P65	CS5#/CKE				
125		PE7	D15[A15/D15]	TIOCB11	MISOB	IRQ7	AN5
126		PE6	D14[A14/D14]	TIOCA11	MOSIB	IRQ6	AN4
127	VCC						
128	SDCLK	P70					
129	VSS						
130		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/ TIOCB10	ET_RX_CLK/REF50CK/ RSPCKB	IRQ5	AN3
131		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/ TIOCA10/PO28	ET_ERXD2/SSLB0		AN2
132		PE3	D11[A11/D11]	MTIOC4B/TIOCB9/PO26/ POE8#	ET_ERXD3/CTS12#/ RTS12#/SS12#/MISOB		AN1
133		PE2	D10[A10/D10]	MTIOC4A/TIOCA9/PO23	RXD12/SMISO12/ SSCL12/RXDX12/SSLB3/ MOSIB	IRQ7-DS	AN0
134		PE1	D9[A9/D9]	MTIOC4C/TIOCD9/PO18	TXD12/SMOSI12/ SSDA12/TXDX12/ SIOX12/SSLB2/RSPCKB		ANEX1
135		PE0	D8[A8/D8]	TIOCC9	SCK12/SSLB1		ANEX0

Table 1.11 List of Pins and Pin Functions (64-Pin TFLGA) (2/2)

Pin No. 64-pin TFLGA	Power Supply Clock System Control	I/O Port	Timers (MTU2a, TPUa, TMR, PPG, RTCa, POE2a)	Communications (SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
E4	TMS	P16	MTIOC3C/MTIOC3D/ TIOCB1/TCLKC/TMO2/ RTCOUT	TXD1/SMOSI1/SSDA1/ MOSIA/SCL2-DS/IERXD/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB	IRQ6	ADTRG0#
E5		PC4	MTIOC3D/MTCLKC/TMCI1/ PO25/POE0#	SCK5/SSLA0/ USB0_DPRPD		
E6	VCC					
E7	VSS					
E8		PB0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
F1	VCC					
F2		P35			NMI	
F3		P31	MTIOC4D/TMCI2/RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
F4		PC5	MTIOC3B/MTCLKD/TMRI2/ PO29	RSPCKA/USB0_ID		
F5		P15	MTIOC0B/MTCLKB/ TIOCB2/TCLKB/TMCI2	RXD1/SMISO1/SSCL1/ CRX1-DS/USB1_DPUPE	IRQ5	
F6		PB1	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/SSDA6	IRQ4-DS	
F7		PB5	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	SCK9		
F8		PB3	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK6		
G1	EXTAL	P36				
G2	TDO	P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ MOSIB/USB0_VBUSEN		
G3	VCC_USB					
G4	VSS_USB					
G5	VCC_USB					
G6		PC6	MTIOC3C/MTCLKA/TMCI2/ PO30	MOSIA/USB0_EXICEN	IRQ13	
G7		PC3	MTIOC4D/TCLKB/PO24	TXD5/SMOSI5/SSDA5/ SDA2/IETXD		
G8		PB6	MTIOC3D/TIOCA5/PO30	RXD9/SMISO9/SSCL9		
H1	XTAL	P37				
H2	TRST#	P17	MTIOC3A/MTIOC3B/ TIOCB0/TCLKD/TMO1/ POE8#	SCK1/MISOA/SDA2-DS/ IETXD/USB1_VBUS	IRQ7	
H3				USB0_DM		
H4				USB0_DP		
H5				USB1_DM		
H6				USB1_DP		
H7		PC2	MTIOC4B/TCLKA/PO21	RXD5/SMISO5/SSCL5/ SSLA3/SCL2/IERXD		
H8		PB7	MTIOC3B/TIOCB5/PO31	TXD9/SMOSI9/SSDA9		

Table 1.13 List of Pins and Pin Functions (48-Pin LQFP) (2/2)

Pin Number 48-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, POE2a)	Communications (SCIc, SCId, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
29		PB0/ PC0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
30	VSS					
31		PA6	MTIC5V/MTCLKB/TIOCA2/ TMCI3/PO22/POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
32		PA4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
33		PA3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
34		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2	IRQ11	
35		PE4	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN012
36		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN011
37		PE2	MTIOC4A/PO23	RXD12/SMISO12/SSCL12/ RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN010
38		PE1	MTIOC4C/PO18	TXD12/SMISO12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		AN009
39	VREFL					
40		P46			IRQ14-DS	AN006
41	VREFH					
42		P42			IRQ10-DS	AN002
43		P41			IRQ9-DS	AN001
44	VREFL0					
45		P40			IRQ8-DS	AN000
46	VREFH0					
47	AVCC0					
48	AVSS0					

Table 4.1 List of I/O Registers (Address Order) (23/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 8800h	MTU2	Timer control register	TCR	8	8	2, 3 PCLKB	2 ICLK	MTU2a
0008 8801h	MTU2	Timer mode register	TMDR	8	8	2, 3 PCLKB	2 ICLK	
0008 8802h	MTU2	Timer I/O control register	TIOR	8	8	2, 3 PCLKB	2 ICLK	
0008 8804h	MTU2	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8805h	MTU2	Timer status register	TSR	8	8	2, 3 PCLKB	2 ICLK	
0008 8806h	MTU2	Timer counter	TCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 8808h	MTU2	Timer general register A	TGRA	16	16	2, 3 PCLKB	2 ICLK	
0008 880Ah	MTU2	Timer general register B	TGRB	16	16	2, 3 PCLKB	2 ICLK	
0008 8880h	MTU5	Timer counter U	TCNTU	16	16	2, 3 PCLKB	2 ICLK	
0008 8882h	MTU5	Timer general register U	TGRU	16	16	2, 3 PCLKB	2 ICLK	
0008 8884h	MTU5	Timer control register U	TCRU	8	8	2, 3 PCLKB	2 ICLK	
0008 8886h	MTU5	Timer I/O control register U	TIORU	8	8	2, 3 PCLKB	2 ICLK	
0008 8890h	MTU5	Timer counter V	TCNTV	16	16	2, 3 PCLKB	2 ICLK	
0008 8892h	MTU5	Timer general register V	TGRV	16	16	2, 3 PCLKB	2 ICLK	
0008 8894h	MTU5	Timer control register V	TCRV	8	8	2, 3 PCLKB	2 ICLK	
0008 8896h	MTU5	Timer I/O control register V	TIORV	8	8	2, 3 PCLKB	2 ICLK	
0008 88A0h	MTU5	Timer counter W	TCNTW	16	16	2, 3 PCLKB	2 ICLK	
0008 88A2h	MTU5	Timer general register W	TGRW	16	16	2, 3 PCLKB	2 ICLK	
0008 88A4h	MTU5	Timer control register W	TCRW	8	8	2, 3 PCLKB	2 ICLK	
0008 88A6h	MTU5	Timer I/O control register W	TIORW	8	8	2, 3 PCLKB	2 ICLK	
0008 88B2h	MTU5	Timer interrupt enable register	TIER	8	8	2, 3 PCLKB	2 ICLK	
0008 88B4h	MTU5	Timer start register	TSTR	8	8	2, 3 PCLKB	2 ICLK	
0008 88B6h	MTU5	Timer compare match clear register	TCNTCMPCLR	8	8	2, 3 PCLKB	2 ICLK	
0008 8900h	POE	Input level control/status register 1	ICSR1	16	16	2, 3 PCLKB	2 ICLK	POE2a
0008 8902h	POE	Output level control/status register 1	OCSR1	16	16	2, 3 PCLKB	2 ICLK	
0008 8908h	POE	Input level control/status register 2	ICSR2	16	16	2, 3 PCLKB	2 ICLK	
0008 890Ah	POE	Software port output enable register	SPOER	8	8	2, 3 PCLKB	2 ICLK	
0008 890Bh	POE	Port output enable control register 1	POECR1	8	8	2, 3 PCLKB	2 ICLK	
0008 890Ch	POE	Port output enable control register 2	POECR2	8	8	2, 3 PCLKB	2 ICLK	
0008 890Eh	POE	Input level control/status register 3	ICSR3	16	16	2, 3 PCLKB	2 ICLK	
0008 9000h	S12AD	A/D control register	ADCSR	8	8	2, 3 PCLKB	2 ICLK	S12ADa
0008 9004h	S12AD	A/D channel select register 0	ADANS0	16	16	2, 3 PCLKB	2 ICLK	
0008 9006h	S12AD	A/D channel select register 1	ADANS1	16	16	2, 3 PCLKB	2 ICLK	
0008 9008h	S12AD	A/D-converted value addition mode select register 0	ADADS0	16	16	2, 3 PCLKB	2 ICLK	
0008 900Ah	S12AD	A/D-converted value addition mode select register 1	ADADS1	16	16	2, 3 PCLKB	2 ICLK	
0008 900Ch	S12AD	A/D-converted value addition count select register	ADADC	8	8	2, 3 PCLKB	2 ICLK	
0008 900Eh	S12AD	A/D control extended register	ADCER	16	16	2, 3 PCLKB	2 ICLK	
0008 9010h	S12AD	A/D start trigger select register	ADSTRGR	8	8	2, 3 PCLKB	2 ICLK	
0008 9012h	S12AD	A/D conversion extended input control register	ADEXICR	16	16	2, 3 PCLKB	2 ICLK	
0008 901Ah	S12AD	A/D temperature sensor data register	ADTSDR	16	16	2, 3 PCLKB	2 ICLK	
0008 901Ch	S12AD	A/D internal reference voltage data register	ADOCDR	16	16	2, 3 PCLKB	2 ICLK	
0008 9020h	S12AD	A/D data register 0	ADDR0	16	16	2, 3 PCLKB	2 ICLK	
0008 9022h	S12AD	A/D data register 1	ADDR1	16	16	2, 3 PCLKB	2 ICLK	
0008 9024h	S12AD	A/D data register 2	ADDR2	16	16	2, 3 PCLKB	2 ICLK	
0008 9026h	S12AD	A/D data register 3	ADDR3	16	16	2, 3 PCLKB	2 ICLK	
0008 9028h	S12AD	A/D data register 4	ADDR4	16	16	2, 3 PCLKB	2 ICLK	
0008 902Ah	S12AD	A/D data register 5	ADDR5	16	16	2, 3 PCLKB	2 ICLK	
0008 902Ch	S12AD	A/D data register 6	ADDR6	16	16	2, 3 PCLKB	2 ICLK	
0008 902Eh	S12AD	A/D data register 7	ADDR7	16	16	2, 3 PCLKB	2 ICLK	
0008 9030h	S12AD	A/D data register 8	ADDR8	16	16	2, 3 PCLKB	2 ICLK	
0008 9032h	S12AD	A/D data register 9	ADDR9	16	16	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (24/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 9034h	S12AD	A/D data register 10	ADDR10	16	16	2, 3 PCLKB	2 ICLK	S12ADa
0008 9036h	S12AD	A/D data register 11	ADDR11	16	16	2, 3 PCLKB	2 ICLK	
0008 9038h	S12AD	A/D data register 12	ADDR12	16	16	2, 3 PCLKB	2 ICLK	
0008 903Ah	S12AD	A/D data register 13	ADDR13	16	16	2, 3 PCLKB	2 ICLK	
0008 903Ch	S12AD	A/D data register 14	ADDR14	16	16	2, 3 PCLKB	2 ICLK	
0008 903Eh	S12AD	A/D data register 15	ADDR15	16	16	2, 3 PCLKB	2 ICLK	
0008 9040h	S12AD	A/D data register 16	ADDR16	16	16	2, 3 PCLKB	2 ICLK	
0008 9042h	S12AD	A/D data register 17	ADDR17	16	16	2, 3 PCLKB	2 ICLK	
0008 9044h	S12AD	A/D data register 18	ADDR18	16	16	2, 3 PCLKB	2 ICLK	
0008 9046h	S12AD	A/D data register 19	ADDR19	16	16	2, 3 PCLKB	2 ICLK	
0008 9048h	S12AD	A/D data register 20	ADDR20	16	16	2, 3 PCLKB	2 ICLK	
0008 9060h	S12AD	A/D sampling state register01	ADSSTR01	16	16	2, 3 PCLKB	2 ICLK	
0008 9070h	S12AD	A/D sampling state register 23	ADSSTR23	16	16	2, 3 PCLKB	2 ICLK	
0008 9800h	AD	A/D data register A	ADDRA	16	16	2, 3 PCLKB	2 ICLK	ADb
0008 9802h	AD	A/D data register B	ADDRB	16	16	2, 3 PCLKB	2 ICLK	
0008 9804h	AD	A/D data register C	ADDRC	16	16	2, 3 PCLKB	2 ICLK	
0008 9806h	AD	A/D data register D	ADDRD	16	16	2, 3 PCLKB	2 ICLK	
0008 9808h	AD	A/D data register E	ADDRE	16	16	2, 3 PCLKB	2 ICLK	
0008 980Ah	AD	A/D data register F	ADDRF	16	16	2, 3 PCLKB	2 ICLK	
0008 980Ch	AD	A/D data register G	ADDRG	16	16	2, 3 PCLKB	2 ICLK	
0008 980Eh	AD	A/D data register H	ADDRH	16	16	2, 3 PCLKB	2 ICLK	
0008 9810h	AD	A/D control/status register	ADCSR	8	8	2, 3 PCLKB	2 ICLK	
0008 9811h	AD	A/D control register	ADCR	8	8	2, 3 PCLKB	2 ICLK	
0008 9812h	AD	A/D control register 2	ADCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 9813h	AD	A/D sampling state register	ADSSTR	8	8	2, 3 PCLKB	2 ICLK	
0008 981Fh	AD	A/D self-diagnostic register	ADDIAGR	8	8	2, 3 PCLKB	2 ICLK	
0008 A000h	SCI0	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIc, SCId
0008 A001h	SCI0	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A002h	SCI0	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A003h	SCI0	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A004h	SCI0	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A005h	SCI0	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A006h	SCI0	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A007h	SCI0	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A008h	SCI0	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A009h	SCI0	I^2C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A00Ah	SCI0	I^2C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 A00Bh	SCI0	I^2C mode register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 A00Ch	SCI0	I^2C status register	SISR	8	8	2, 3 PCLKB	2 ICLK	
0008 A00Dh	SCI0	SPI mode register	SPMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A020h	SCI1	Serial mode register	SMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A021h	SCI1	Bit rate register	BRR	8	8	2, 3 PCLKB	2 ICLK	
0008 A022h	SCI1	Serial control register	SCR	8	8	2, 3 PCLKB	2 ICLK	
0008 A023h	SCI1	Transmit data register	TDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A024h	SCI1	Serial status register	SSR	8	8	2, 3 PCLKB	2 ICLK	
0008 A025h	SCI1	Receive data register	RDR	8	8	2, 3 PCLKB	2 ICLK	
0008 A026h	SCI1	Smart card mode register	SCMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A027h	SCI1	Serial extended mode register	SEMR	8	8	2, 3 PCLKB	2 ICLK	
0008 A028h	SCI1	Noise filter setting register	SNFR	8	8	2, 3 PCLKB	2 ICLK	
0008 A029h	SCI1	I^2C mode register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 A02Ah	SCI1	I^2C mode register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (31/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 C095h	PORTA	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C096h	PORTB	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C097h	PORTB	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C098h	PORTC	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C099h	PORTC	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Ah	PORTD	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Bh	PORTD	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Ch	PORTE	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Dh	PORTE	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Eh	PORTF	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Fh	PORTF	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A0h	PORTG	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A1h	PORTG	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A4h	PORTJ	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A5h	PORTJ	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0C0h	PORT0	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C1h	PORT1	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C2h	PORT2	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C3h	PORT3	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C4h	PORT4	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C5h	PORT5	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C6h	PORT6	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C7h	PORT7	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C8h	PORT8	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C9h	PORT9	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CAh	PORTA	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CBh	PORTB	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CCh	PORTC	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CDh	PORTD	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CEh	PORTE	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CFh	PORTF	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0D0h	PORTG	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0D2h	PORTJ	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E0h	PORT0	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E2h	PORT2	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E5h	PORT5	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E9h	PORT9	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EAh	PORTA	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EBh	PORTB	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0ECh	PORTC	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EDh	PORTD	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EEh	PORTE	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0F0h	PORTG	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C100h	MPC	CS output enable register	PFCSE	8	8	2, 3 PCLKB	2 ICLK	MPC
0008 C102h	MPC	CS output pin select register 0	PFCSS0	8	8	2, 3 PCLKB	2 ICLK	
0008 C103h	MPC	CS output pin select register 1	PFCSS1	8	8	2, 3 PCLKB	2 ICLK	
0008 C104h	MPC	Address output enable register 0	PFAOE0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C105h	MPC	Address output enable register 1	PFAOE1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C106h	MPC	External bus control register 0	PFBCR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C107h	MPC	External bus control register 1	PFBCR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C10Eh	MPC	Ethernet control resister 1	PFENET	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (41/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
000A 006Eh	USB0	Pipe cycle control register	PIPEPERI	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0070h	USB0	Pipe 1 control register	PIPE1CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0072h	USB0	Pipe 2 control register	PIPE2CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0074h	USB0	Pipe 3 control register	PIPE3CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0076h	USB0	Pipe 4 control register	PIPE4CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0078h	USB0	Pipe 5 control register	PIPE5CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	USBa
000A 007Ah	USB0	Pipe 6 control register	PIPE6CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 007Ch	USB0	Pipe 7 control register	PIPE7CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 007Eh	USB0	Pipe 8 control register	PIPE8CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	
000A 0080h	USB0	Pipe 9 control register	PIPE9CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB)*6	

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC, VCC_USB	–0.3 to +4.6	V
V_{BATT} power supply voltage		V_{BATT}	–0.3 to +4.6	V
Input voltage (except for ports for 5 V tolerant*1)		V_{in}	–0.3 to VCC + 0.3	V
Input voltage (ports for 5 V tolerant*1)		V_{in}	–0.3 to +5.8	V
Reference power supply voltage		VREFH	–0.3 to VCC + 0.3	V
Analog power supply voltage		AVCC*2	–0.3 to +4.6	V
Analog input voltage		V_{AN}	–0.3 to VCC + 0.3	V
Operating temperature	D version	T_{opr}	–40 to +85	°C
	G version		–40 to +105	°C
Storage temperature		T_{stg}	–55 to +125	°C

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded.

Note 1. Ports 07, 12 to 17, 20, 21, 30 to 33, 67, and C0 to C3 are 5 V tolerant.

Note 2. Connect AVCC0 to VCC. When neither the A/D converter nor the D/A converter is in use, do not leave the AVCC0, VREFH/VREFH0, AVSS0, and VREFL/VREFL0 pins open. Connect the AVCC0 and VREFH/VREFH0 pins to VCC, and the AVSS0 and VREFL/VREFL0 pins to VSS, respectively.

Table 5.5 DC Characteristics (4) (for G Version (+85 < Ta ≤ +105°C))

Conditions: VCC = AVCC0 = VREFH = VCC_USB = V_{BATT} = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V, $T_a = T_{opr}$

Item				Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Supply current*1	High-speed operating mode	Max.*2		I_{CC}*3	—	—	115	mA	ICLK = 100 MHz PCLKA = 100MHz PCLKB = 50 MHz FCLK = 50 MHz BCLK = 100MHz
		Normal *4	Peripheral function: clock signal supplied*4		—	52	—		
			Peripheral function: clock signal stopped*4		—	40	—		
		Sleep mode			—	25	80		
		All-module-clock-stop mode (reference value)			—	20	53		
		Increased by BGO operation*5			—	15	—		
	Low-speed operating mode 1*6				—	4	—		ICLK = 1 MHz
	Low-speed operating mode 2				—	1	—		ICLK = 32.768 kHz
	Software standby mode				—	0.2	9		
	Deep software standby mode	Power supplied to RAM and USB resume detecting unit			—	22	200	µA	
		Power not supplied to RAM and USB resume detecting unit	Power-on reset circuit and low-power consumption function disabled		—	21	60		
			Power-on reset circuit and low-power consumption function enabled		—	6.2	28		
	Increase when the RTC is operating		When a crystal oscillator for low clock loads is in use		—	1.0	—		
			When a crystal oscillator for standard clock loads is in use		—	3.0	—		
	RTC operating while VCC is off (with the battery backup function, only the RTC and sub-clock oscillator operate)		When a crystal oscillator for low clock loads is in use		—	0.9	—		V_{BATT} = 2.0 V, VCC = 0V
					—	1.6	—		V_{BATT} = 3.3 V, VCC = 0V
			When a crystal oscillator for standard clock loads is in use		—	1.7	—		V_{BATT} = 2.0 V(for products with 100 pins or more), VBATT = 2.3 V (for the 64-pin product), VCC = 0V
					—	3.3	—		V_{BATT} = 3.3 V, VCC = 0V
Analog power supply current*7	During 12-bit A/D conversion (including temperature sensor)			I_{AVCC0}	—	2.3	3.2	mA	
	During 10-bit A/D conversion			I_{VREFH}*9	—	1.0	1.65	mA	
	During D/A conversion (per unit)				—	0.7	1.0	mA	
	Waiting for A/D, D/A conversion (all units)*10			—	—	25	35	µA	
	A/D, D/A converter in standby mode (all units)*10				—	0.1	5	µA	
Reference power supply current	During 12-bit A/D conversion			I_{VREFH0}	—	0.6	0.7	mA	
	Waiting for 12-bit A/D conversion (per unit)				—	0.5	0.6	mA	
	12-bit A/D converter in standby mode (per unit)				—	0.1	2.0	µA	
RAM standby voltage				V_{RAM}	2.7	—	—	V	
VCC rising gradient				SrVCC	8.4	—	20000	µs/V	
VCC falling gradient*8				SfVCC	8.4	—	—	µs/V	

5.3.5 Bus Timing

Table 5.16 Bus Timing (packages with 177 to 144 pins)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0,
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V,
ICLK = 8 to 100 MHz, BCLK pin = 8 to 50 MHz, SDCLK pin = 8 to 50MHz, $T_a = T_{opr}$
Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, I_{OH} = -1.0 mA, I_{OL} = 1.0 mA, C = 30 pF
High drive output is selected by the drive capacity control register.

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	15	ns	Figure 5.17 to Figure 5.22
Byte control delay time	t_{BCD}	—	15	ns	
CS# delay time	t_{CSD}	—	15	ns	
ALE delay time	t_{ALED}	—	20	ns	
RD# delay time	t_{RSD}	—	15	ns	
Read data setup time	t_{RDS}	15	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	15	ns	
Write data delay time	t_{WDD}	—	15	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	15	—	ns	Figure 5.23
WAIT# hold time	t_{WTH}	0	—	ns	
Address delay time 2 (SDRAM)	t_{AD2}	1	15	ns	Figure 5.24 to Figure 5.30
CS# delay time 2 (SDRAM)	t_{CSD2}	1	15	ns	
DQM delay time (SDRAM)	t_{DQMD}	1	15	ns	
CKE delay time (SDRAM)	t_{CKED}	1	15	ns	
Read data setup time 2 (SDRAM)	t_{RDS2}	12	—	ns	
Read data hold time 2 (SDRAM)	t_{RDH2}	0	—	ns	
Write data delay time 2 (SDRAM)	t_{WDD2}	—	15	ns	
Write data hold time 2 (SDRAM)	t_{WDH2}	1	—	ns	
WE# delay time (SDRAM)	t_{WED}	1	15	ns	
RAS# delay time (SDRAM)	t_{RASD}	1	15	ns	
CAS# delay time (SDRAM)	t_{CASD}	1	15	ns	

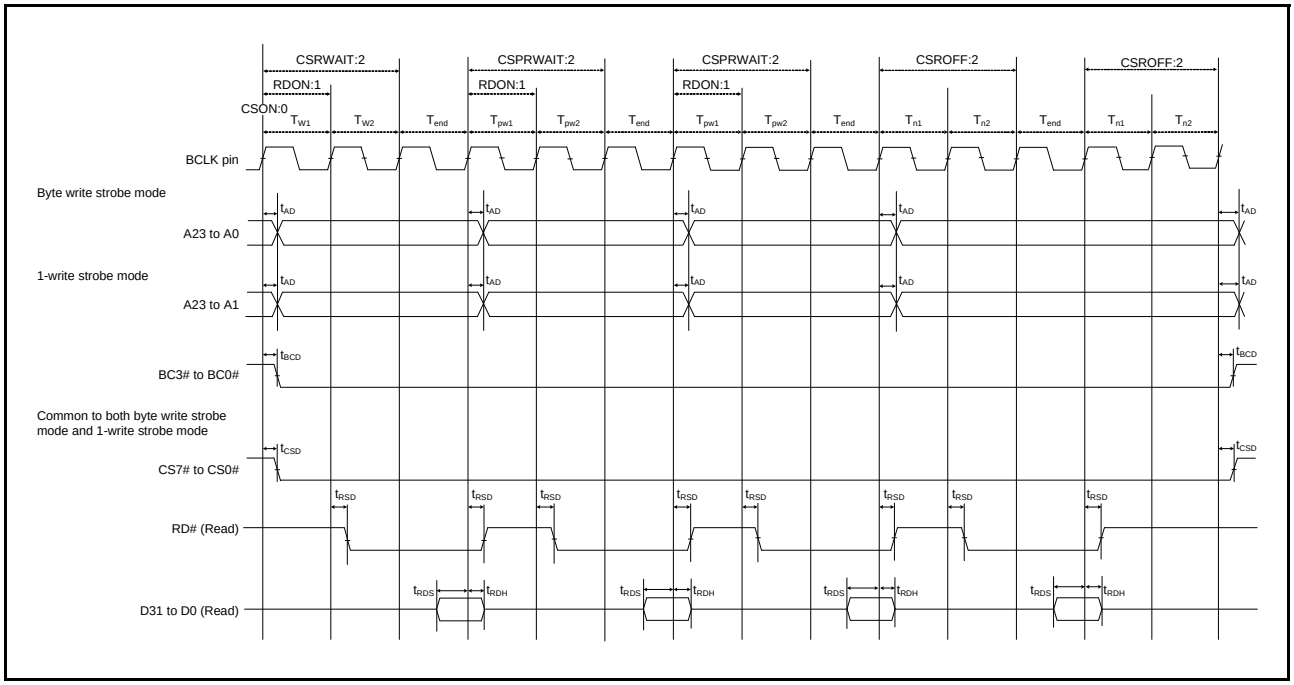
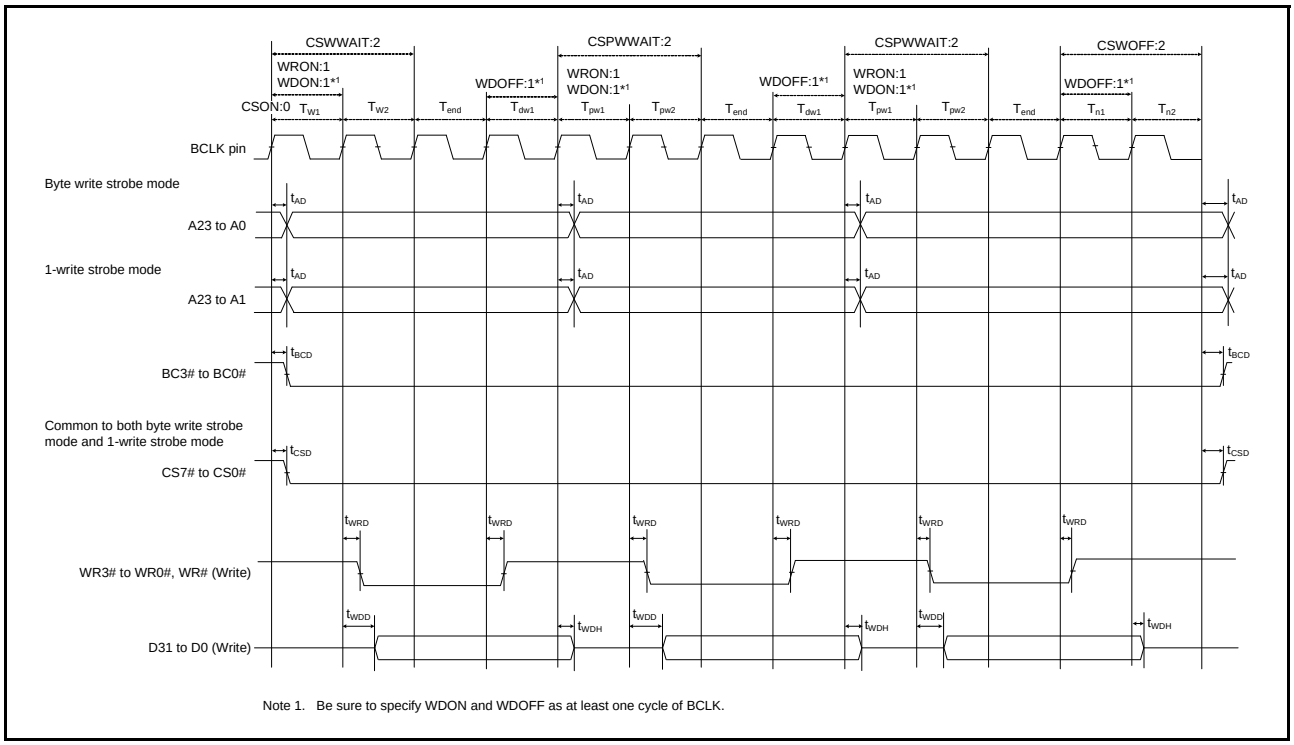
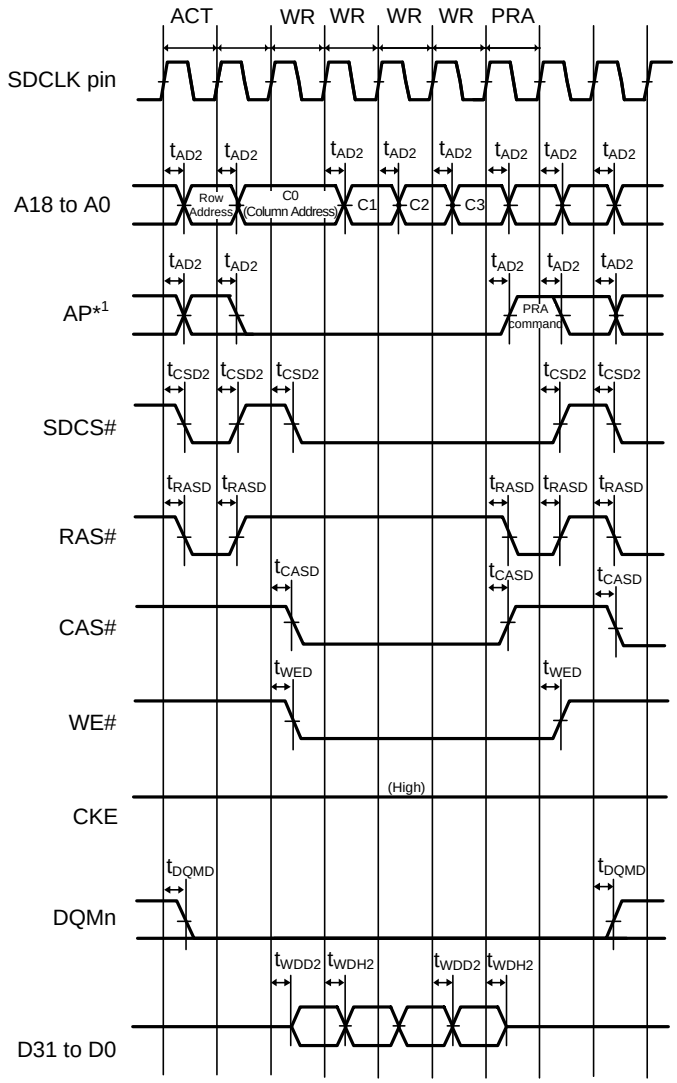


Figure 5.21 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)



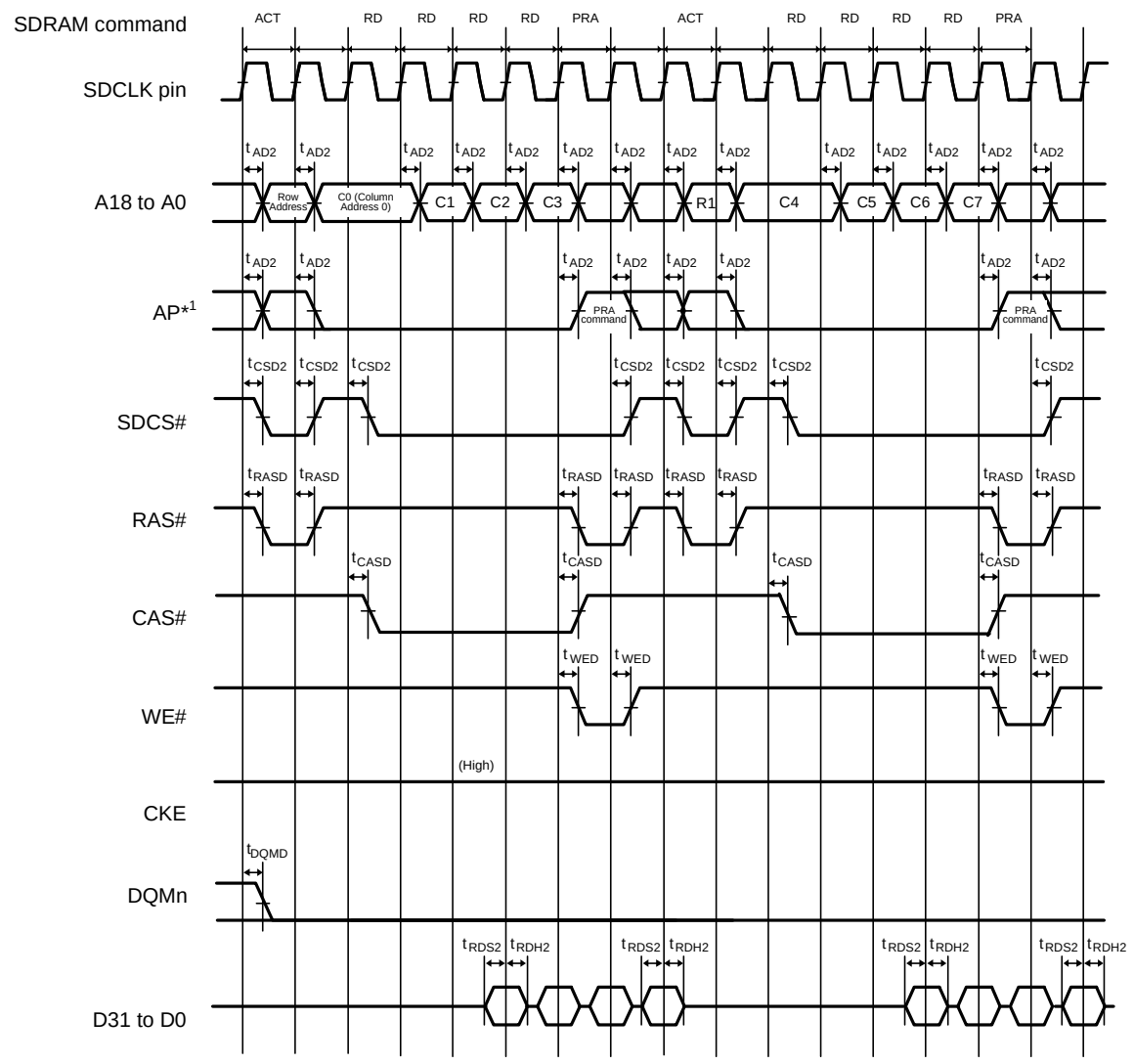
Note 1. Be sure to specify WDON and WDOFF as at least one cycle of BCLK.

Figure 5.22 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.27 SDRAM Space Multiple Write Bus Timing



Note 1: Address pins for output of the precharge-setting command (Precharge-sel) for SDRAM.

Figure 5.28 SDRAM Space Multiple Read Line Stride Bus Timing

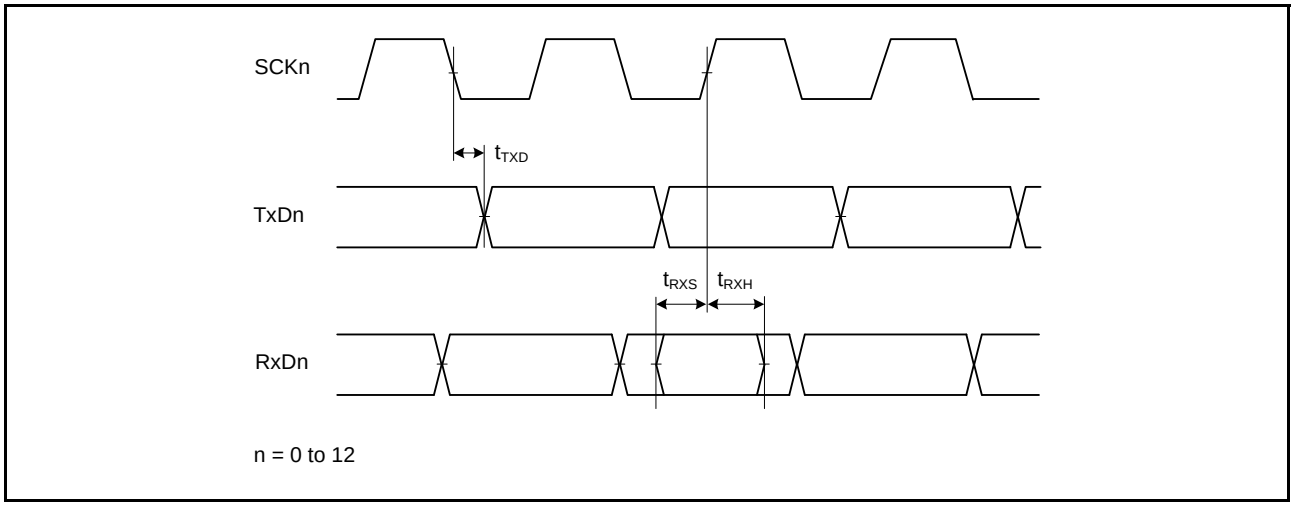


Figure 5.40 SCI Input/Output Timing: Clock Synchronous Mode

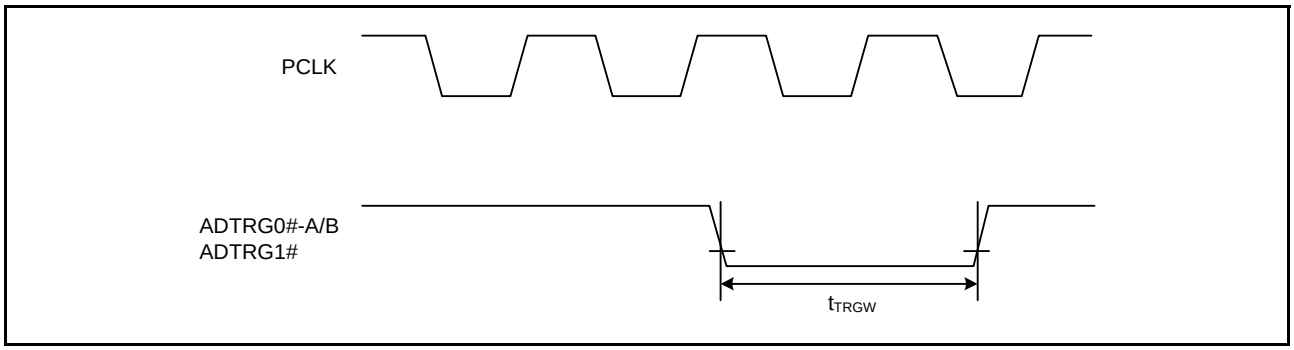


Figure 5.41 A/D Converter External Trigger Input Timing

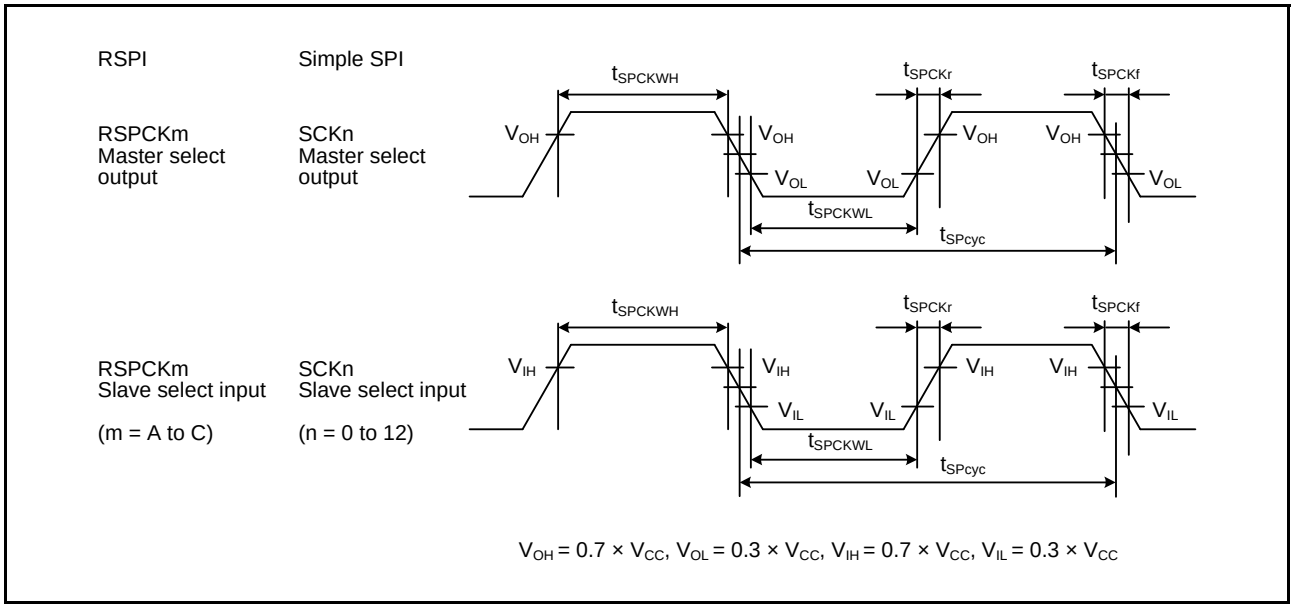


Figure 5.42 RSPI Clock Timing and Simple SPI Clock Timing

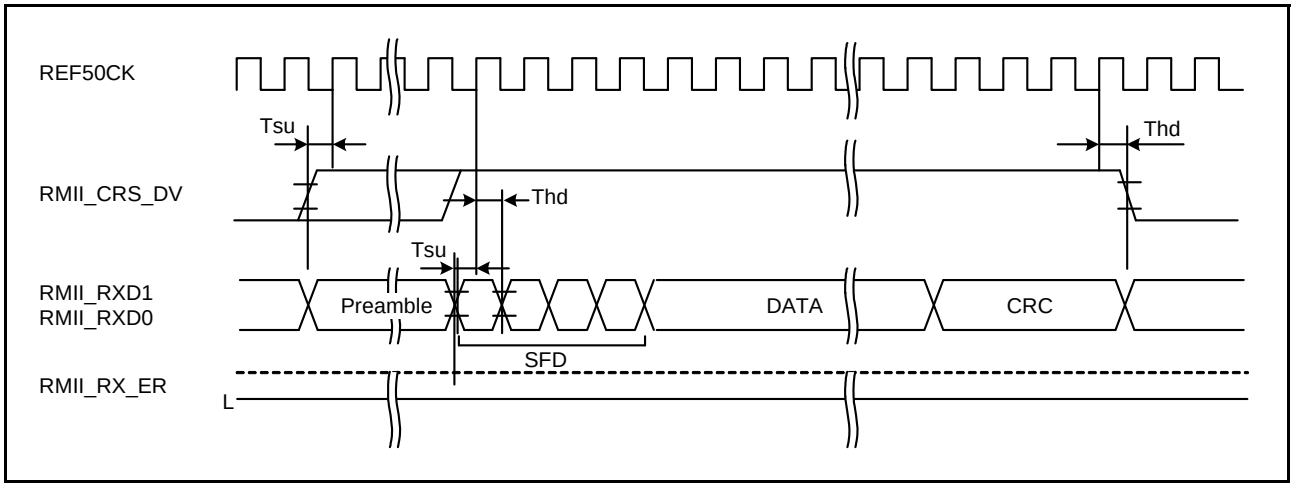


Figure 5.50 RMII Reception Timing (Normal Operation)

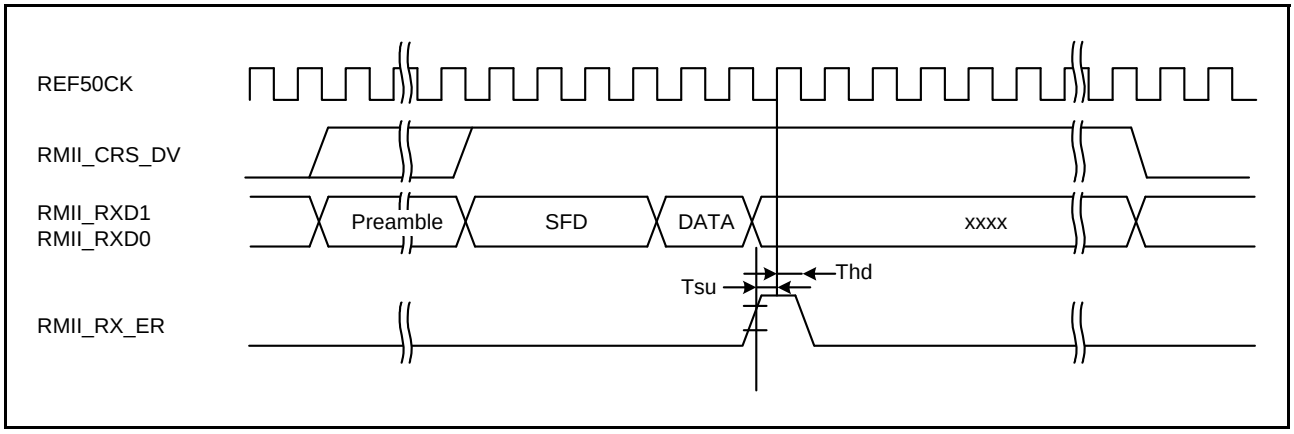


Figure 5.51 RMII Reception Timing (Error Occurrence)

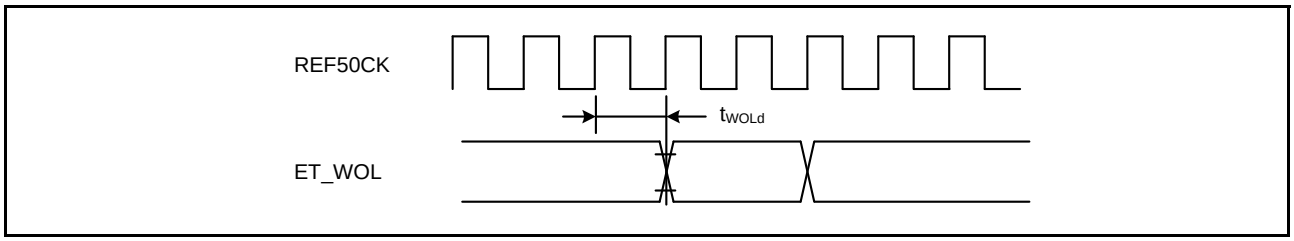


Figure 5.52 WOL Output Timing (RMII)

5.6 D/A Conversion Characteristics

Table 5.31 D/A Conversion Characteristics

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to VCC
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time	—	—	3.0	µs	20-pF capacitive load
Absolute accuracy	—	±2.0	±4.0	LSB	2-MΩ resistive load
	—	—	±3.0	LSB	4-MΩ resistive load
	—	—	±2.0	LSB	10-MΩ resistive load
RO output resistance	—	3.6	—	kΩ	

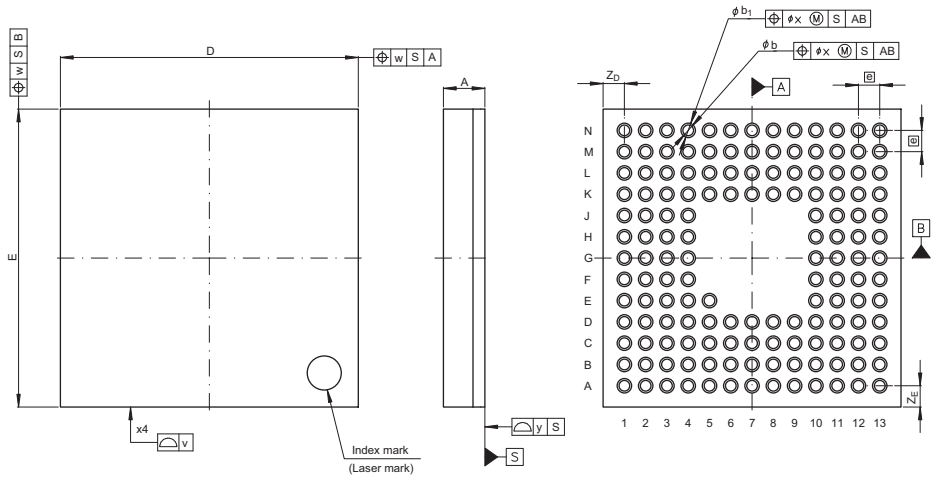
5.7 Temperature Sensor Characteristics

Table 5.32 Temperature Sensor Characteristics

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to VCC
VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V
$T_a = T_{opr}$

Item	Min.	Typ.	Max.	Unit	Test Conditions
Relative accuracy	—	±1	—	°C	
Temperature slope	—	4.1	—	mV/°C	
Output voltage (@25°C)	—	1.26	—	V	
Temperature sensor start time	—	—	30	µs	
Sampling time	—	—	5	µs	

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TFLGA145-7x7-0.50	PTLG0145KA-A	145F0G	0.1g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	7.0	—
E	—	7.0	—
v	—	—	0.15
w	—	—	0.20
A	—	—	1.05
e	—	0.5	—
b	0.21	0.25	0.29
b_1	0.29	0.34	0.39
x	—	—	0.08
y	—	—	0.10
Z_D	—	0.5	—
Z_E	—	0.5	—

Figure D 145-pin TFLGA (PTLG0145KA-A)

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

   Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

   — The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.